NASA SBIR 2009 Phase I Solicitation

O1.06 Long Range Optical Telecommunications

Lead Center: JPL

Participating Center(s): ARC, GRC, GSFC

This subtopic seeks innovative technologies for long range Optical Telecommunications supporting the needs of space missions. Proposals are sought in the following areas:

- **Systems**: Technologies relating to acquisition, tracking and sub-micro-radian pointing of the optical communications beam under typical deep-space ranges (to 40 AU) and spacecraft micro-vibration environments.

- **Small lightweight two-axis gimbals**: Approximately 1 kg in mass capable to actuating payload mass of approximately 6 kg at rates up to 5 degrees/second, with less than 30 micro-radian rms error and blind-pointing accuracy of less than 35 micro-radian. Assume that the payload is shaped as an 8-cm diameter cylinder, 30-cm long, with uniformly distributed mass. Proposals should come up with innovative pragmatic designs that can be flown in space.

- **Photon counting Si, InGaAs, and HgCdTe detectors and arrays**: For the 1000 to 1600 nm wavelength range with single photon detection efficiencies greater than 60% and output jitters less than 20 pico-second, active area greater than 20 microns/pixel, and 1 dB saturation rates of at least 100 mega-photons (detected) per pixel and dark count rates of less than 1 MHz/square-mm.

- **Single-photon-sensitive, high-bandwidth, linear mode photo-detectors**: With high bandwidth (>1GHz), high gain (>1000), low-noise (uncooled photon counting imagers)

- **Uncooled photon counting imagers**: With >1024 x 1024 formats, ultra low dark count rates and visible to near-IR sensitivity.

- **Ultra-low fixed pattern non-uniformity NIR imagers**: With large format (1024x1024), non-uniformity of less than 0.1%, low noise (0.7) quantum efficiency.

- **Radiation hard photon counting detectors and arrays**: For the 1000 to 1600 nm wavelength range with single photon detection efficiencies greater than 40% and 1dB saturation rates of at least 30 mega-photons/pixel and operational temperatures above 220K and dark count rates of Radiation levels of at least 100 Mrad (unprotected).
• **Isolation platforms:** Compact, lightweight, low power, broad bandwidth (0.1 Hz -3 kHz) disturbance rejection.

• **Laser Transmitters:** Space-qualifiable, greater than 20% wall plug efficiency, lightweight, 20-500 pico-second pulse-width (10 to >100 MHz PRF), tunable (~0.2 nm) pulsed 1064-nm or 1550-nm laser transmitter fiber MOPA sources with greater than 1 kW of peak power per pulse (over the entire pulse-repetition rate), with Stimulated Brillouin Scattering suppression and >10 W of average power, near transform limited spectral width, and less than 10 pico-second pulse rise and fall times. Also of interest for the laser transmitter are: robust and compact packaging with radiation tolerant electronics inherent in the design, and high speed electrical interface to support output of pulse position modulation encoding of sub nanosecond pulses and inputs such as Spacewire, Firewire or Gigabit Ethernet. Detailed description of approaches to achieve the stated efficiency is a must.

• **Low-cost ground-based telescope assembly:** With diameter greater than 2-m, primary mirror with f-number of ~1.1 and Cassegrain focus to be used as optical communication receiver optics. Maximum RMS surface figure error of 1-wave at 1000 nm wavelength. Telescope shall be positioned with a two-axis gimbal capable of 0.25mrad pointing. Combined telescope, gimbal and dome shall be manufacturable in quantity (tens) for ~$1.5M each.

• **Daytime atmospheric compensation techniques:** Capable of removing all significant atmospheric turbulence distortions (tilt and higher-order components) on an uplink laser beam; and/or for a 2-m diameter downlink receiver telescope. Also of interest are technologies to compensate for the static and dynamic (gravity sag and thermal) aberrations of 2-m diameter telescopes with a surface figure of 10’s of waves.

Research should be conducted to convincingly prove technical feasibility during Phase 1, with clear pathways to demonstrating and delivering functional hardware, meeting all objectives and specifications, in Phase 2.